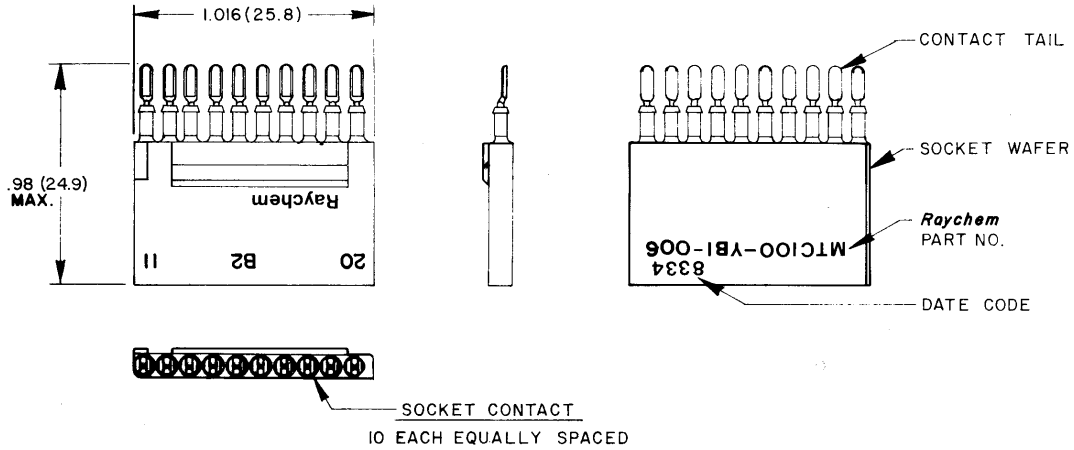


REVISIONS			
LTR	DESCRIPTION	DATE	APPROVED
N/C	INITIAL RELEASE, ECN NO. T-4127	4-2-83	HYA



- NOTES:
- MATERIAL:** I-A SOCKET WAFER; INSERT MATERIAL HIGH GRADE POLYARYLENE THERMOPLASTIC
I-B SOCKET CONTACT; COPPER ALLOY PER QQ-B-750 Sn63
 - FINISH:** 2-A SOCKET WAFER; FINISH TO BE AS MOLDED
2-B SOCKET CONTACT ENGAGING AREA; GOLD PLATE PER MIL-G-45204, CLASS I
2-C CONTACT TAIL; SOLDER COATED PER QQ-S-571
 - WAFER:** WAFER DESIGNED FOR USE WITH CONNECTORS DESIGNED TO **Raychem** SPECIFICATION D-6012
 - WEIGHT (MAX);** LBS. | GRAMS
.0044 | 2.02

© Raychem Corporation 1982

SPECIFICATION CONTROL DRAWING

ITEM	QTY	PART NO.	DWG OR SPEC. NO.	DESCRIPTION
		PARTS LIST		
		THIRD ANGLE PROJECTION	MATERIAL	DRAWN <i>Hawkins</i>
			FINISH	CHECKED <i>JS</i>
				APPROVED <i>Blain</i>
				DATE 8-9-82
				APPROVED <i>HYA</i>
				DATE 4-2-83
NEXT ASSY		USED ON		Raychem <small>RAYCHEM CORPORATION 300 CONSTITUTION DRIVE MENLO PARK, CALIFORNIA 94025</small> TITLE WAFER "B2" SOCKET, SPECIAL 1" FOR USE IN MTC100 2" CONNECTOR, 125°C OPERATING TEMP. FOR 20-26 AWG ROUND WIRE TERMINATION MTC100 SERIES
<small>THIS DRAWING AND THE INFORMATION SET FORTH HEREON ARE THE PROPERTY OF RAYCHEM CORPORATION AND ARE TO BE HELD IN TRUST AND CONFIDENCE. PUBLICATION, DUPLICATION, DISCLOSURE, OR USE FOR ANY PURPOSE NOT EXPRESSLY AUTHORIZED IN WRITING BY RAYCHEM CORPORATION IS PROHIBITED.</small>				
		UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND TOLERANCES ARE	DEC XX ±.02 DEC XXX ±.005 ANGLES ± MM ±	B FSCM NO. 06090 DWG NO. MTC100-YBI-006
				PROJECT NO. SCALE NONE DO NOT SCALE THIS DWG SHEET OF

If this document is printed it becomes uncontrolled.
Check with the web for latest revision.